

# 2SA0683 (2SA683), 2SA0684 (2SA684)

## Silicon PNP epitaxial planar type

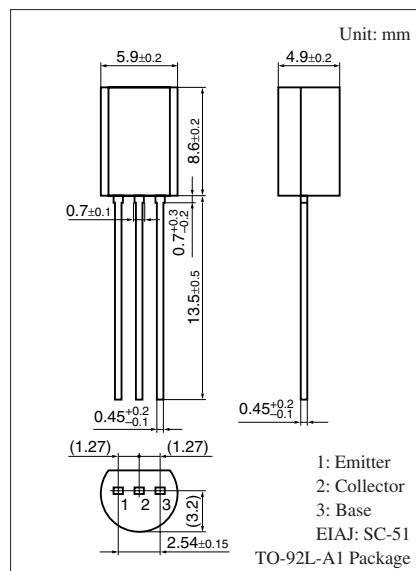
For low-frequency power amplification and driver amplification  
Complementary to 2SC1383, 2SC1384

### ■ Features

- Allowing supply with the radial tapping

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter		Symbol	Rating	Unit
Collector-base voltage (Emitter open)	2SA0683	$V_{CBO}$	−30	V
	2SA0684		−60	
Collector-emitter voltage (Base open)	2SA0683	$V_{CEO}$	−25	V
	2SA0684		−50	
Emitter-base voltage (Collector open)		$V_{EBO}$	−5	V
Collector current		$I_C$	−1	A
Peak collector current		$I_{CP}$	−1.5	A
Collector power dissipation		$P_C$	1	W
Junction temperature		$T_j$	150	°C
Storage temperature		$T_{stg}$	−55 to +150	°C



### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	2SA0683 2SA0684	$V_{CBO}$ $I_C = -10 \mu\text{A}$ , $I_E = 0$	-30			V
			-60			
Collector-emitter voltage (Base open)	2SA0683 2SA0684	$V_{CEO}$ $I_C = -2 \text{ mA}$ , $I_B = 0$	-25			V
			-50			
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = -10 \mu\text{A}$ , $I_C = 0$	-5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -20 \text{ V}$ , $I_E = 0$			-0.1	$\mu\text{A}$
Forward current transfer ratio *1	$h_{FE1}$ *2	$V_{CE} = -10 \text{ V}$ , $I_C = -500 \text{ mA}$	85		340	—
	$h_{FE2}$	$V_{CE} = -5 \text{ V}$ , $I_C = -1 \text{ A}$	50			
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -500 \text{ mA}$ , $I_B = -50 \text{ mA}$		-0.2	-0.4	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = -500 \text{ mA}$ , $I_B = -50 \text{ mA}$		-0.85	-1.20	V
Transition frequency	$f_T$	$V_{CB} = -10 \text{ V}$ , $I_E = 50 \text{ mA}$ , $f = 200 \text{ MHz}$		200		MHz
Collector output capacitance (Common base, input open circuited)	$C_{ob}$	$V_{CB} = -10 \text{ V}$ , $I_E = 0$ , $f = 1 \text{ MHz}$		20	30	pF

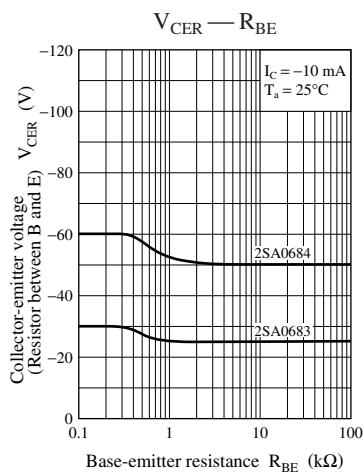
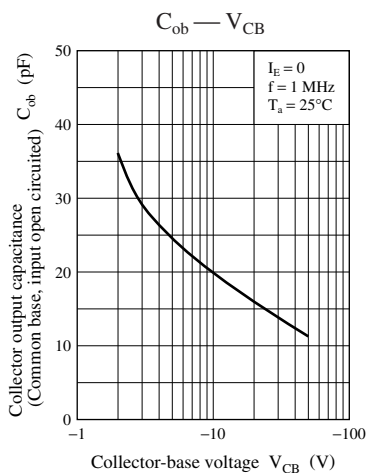
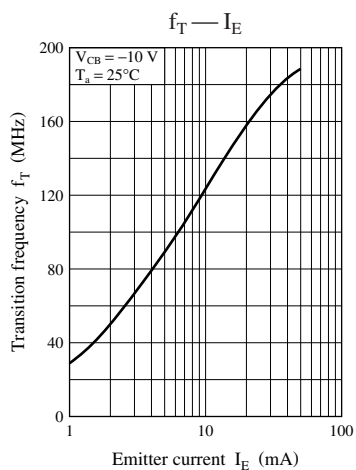
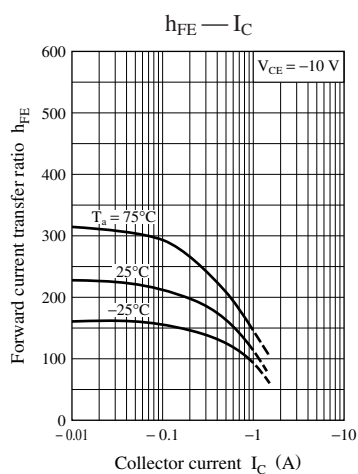
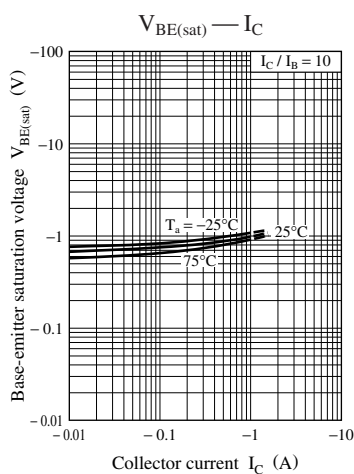
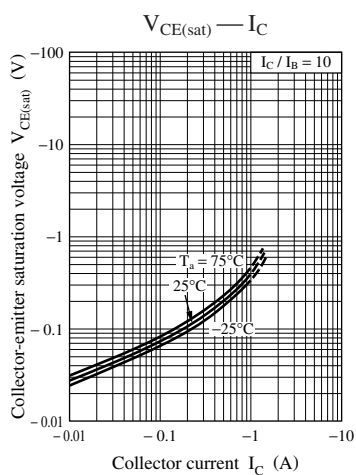
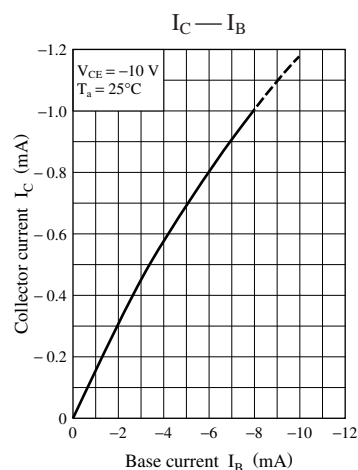
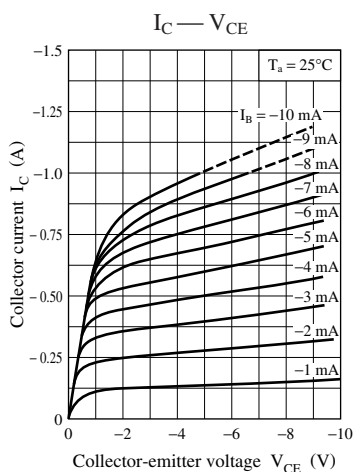
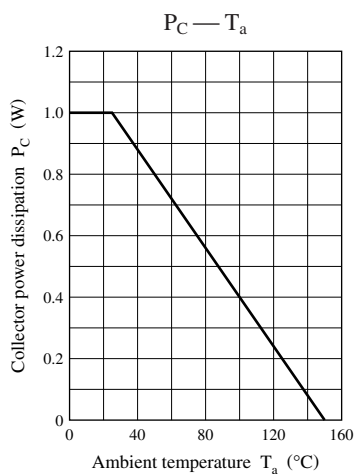
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

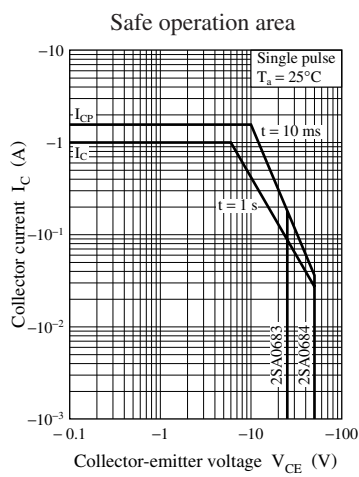
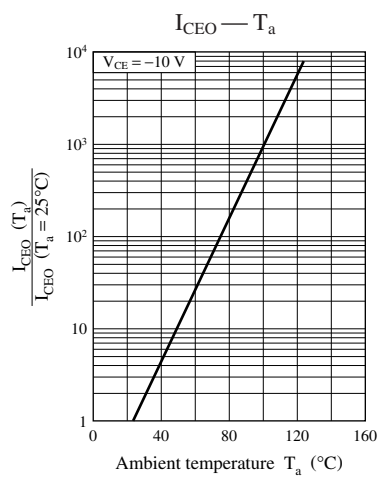
2. \*1: Pulse measurement

\*2: Rank classification

Rank	Q	R	S
$h_{FE}$	85 to 170	120 to 240	170 to 340

Note) The part numbers in the parenthesis show conventional part number.





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